

NEWMEN TECHNOLOGY

BOM(A)

Material Classification: Electronic Material Number: Material Name: M

Item	Material Number	Commodity Specification	Qty
1		PCB Board RFMSO25B	1
2		Chip resistance 1Ω 0603 ±5%	1
3		Chip resistance 10Ω 0603 ±5%	2
4		Chip resistance 100Ω 0603 ±5%	1
5		Chip resistance 390Ω 0603 ±5%	1
6		Chip resistance 1.5K 0603 ±5%	1
7		Chip resistance 3K 0603 ±5%	2
8		Chip resistance 3.9K 0603 ±5%	2
9		Chip resistance 10K 0603 ±5%	1
10		Chip resistance 15K 0603 ±5%	5
11		Chip resistance 30K 0603 ±5%	1
12		Chip resistance 39K 0603 ±5%	1
13		Chip resistance 51K 0603 ±5%	3
14		Chip resistance 100K 0603 ±5%	1
15		Chip metal membrane resistance 147K 0603 ±1%	1
16		Chip metal membrane resistance 200K 0603 ±1%	1
17		NPO Chip Capacitance 7PF/50V 0603 ±5%	1
18		NPO Chip Capacitance 15PF/50V 0603 ±5%	1
19		NPO Chip Capacitance 20PF/50V 0603 ±5%	2
20		NPO Chip Capacitance 100PF/50V 0603 ±5%	4
21		NPO Chip Capacitance 120PF/50V 0603 ±5%	1
22		NPO Chip Capacitance 151/50V 0603 ±5%	1
23		Chip Capacitance 102/50V 0603 ±20%	3
24		Chip Capacitance 103/50V 0603 +80%~-20%	1
25		Chip Capacitance 104/50V 0603 ±10%	1
26		Chip Capacitance 104/50V 0603 +80%~-20%	6
27		Electrolysis capacitance 10uF/25V 4*7 ±20%	1
28		Tantalum Capacitance 22uF/16V 5.5*8mm ±20%	1
29		Electrolysis capacitance 47μF/10V 4*7mm ±20%	1
30		Electrolysis capacitance 47μF/16V 5*5mm ±20%	1
31		Ceramic resonator 6.0MHz 3P ±0.3%	1
32		Ceramic resonator 18MHz 2PIN ±0.5%	1
33		Quartz crystalloid vibration 13.5215MHz 2PIN ±20PPM	1
34		Quartz crystalloid vibration 13.5715MHz 2PIN ±20PPM	1
35		Chip inductance 1uH 0805 ±5%	1
36		Chip inductance 270uH 1210 ±10%	1
37		Light diode HLMP-ED80	1
38		Chip diode 4148	3
39		SMD DIODE KDR729	1
40		Chip dynatron 2SC2714 SOT-23 Level=Y	3
41		Chip IC EM78257B (RFOZ6BAT)	1
42		Photoelectricity IC A2030	1
43		Up-grade stress IC RT9261-33CX	1
44		Switch on-off SK12D01VG4	2
45		Mini on-off 60-70G	3
46		Eradiate tall foot crystalloid LTE-322L1-M J Level. Purple	1
47		Receive tall foot crystalloid LTR-5576DHL2 D Level. Blue	1
48		Spring	1
49		Spring	1
		Total:	76

Remarks:

Confirmed by general manager ☐ Confirmed by manager ☐ Confirmed by ☐
First confirmed by ☐ Prepared by ☐



odel:MS-025OR

Site
2003-3-10
RRXY
R7, R9
R13
RZ
R5
RB2,R32
R2, R4
R6
RXY,RP1,RP2,RP3,RP4
R1
R10
RB1,RCK,RPD
R3
R21
R22
C6
C15
C3,C12
C5,C13,C21,CB
C8
C11
C9,C10,C16
C1
C31
CB2,CB1,CB4,CB3,CC1,C2
CB5
TC1
EC1
EC2
Y1
Y2
X1
X2
L2
L1
LED1
DL,DR,DM
DS1
Q2,Q3,Q4
U3
U2
Q1
SW1,SW2
SWM SWL,SWR. For the reference of production technical specification
IRZY
PHZY
BAT+ For the reference of production technical specification
BAT- For the reference of production technical specification
PCS

d by R&D director ☐